

<b>PATENT ASSIGNMENT COVER SHEET</b>
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Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT5438598

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MASAHIRO HONGOU	02/21/2019
KAZUMI OZAWA	02/21/2019
TAKASHI MIURA	02/21/2019
SHIE MATSUNAGA	02/21/2019
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	TOYO SEIKAN CO., LTD.
<b>Street Address:</b>	18-1, HIGASHI-GOTANDA 2-CHOME, SHINAGAWA-KU
<b>City:</b>	TOKYO
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	141-8640
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16335568
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(202)293-7860
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	202-293-7060
<b>Email:</b>	mguerrero@sughrue.com, sughrue@sughrue.com
<b>Correspondent Name:</b>	SUGHRUE MION, PLLC
<b>Address Line 1:</b>	2100 PENNSYLVANIA AVENUE, N.W.
<b>Address Line 2:</b>	SUITE 800
<b>Address Line 4:</b>	WASHINGTON, D.C. 20037-3213
<b>ATTORNEY DOCKET NUMBER:</b>	Q245712
<b>NAME OF SUBMITTER:</b>	MELANIE GUERRERO
<b>SIGNATURE:</b>	/Melanie Guerrero/
<b>DATE SIGNED:</b>	03/25/2019
<b>Total Attachments: 2</b>	
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<b>NAME OF SOLE OR FIRST INVENTOR:</b>	
Given Name (first and middle [if any])	Masahiro
Family Name or Surname	HONGOU
Inventor's signature	<i>Masahiro Hongou</i>
Date	February 21, 2019
Residence:	Yokohama-shi, Kanagawa, Japan
Mailing Address:	c/o Toyo Seikan Co., Ltd., Technical Headquarters, 1-70, Yako 1-chome, Tsurumi-ku, Yokohama-shi, Kanagawa 230-0001 Japan
<b>NAME OF SECOND INVENTOR:</b>	
Given Name (first and middle [if any])	Kazumi
Family Name or Surname	OZAWA
Inventor's signature	<i>Kazumi Ozawa</i>
Date	February 21, 2019
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Mailing Address:	c/o Toyo Seikan Group Holdings, Ltd., Corporate Research & Development, 22-4, Okazawa-cho, Hodogaya-ku, Yokohama-shi, Kanagawa 240-0062 Japan
<b>NAME OF THIRD INVENTOR:</b>	
Given Name (first and middle [if any])	Takashi
Family Name or Surname	MIURA
Inventor's signature	<i>Takashi Miura</i>
Date	February 21, 2019
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Mailing Address:	c/o Toyo Seikan Co., Ltd., Technical Headquarters, 1-70, Yako 1-chome, Tsurumi-ku, Yokohama-shi, Kanagawa 230-0001 Japan
<b>NAME OF FOURTH INVENTOR:</b>	
Given Name (first and middle [if any])	Shie
Family Name or Surname	MATSUNAGA
Inventor's signature	<i>Shie Matsunaga</i>
Date	February 21, 2019
Residence:	Yokohama-shi, Kanagawa, Japan
Mailing Address:	c/o Toyo Seikan Co., Ltd., Technical Headquarters, 1-70, Yako 1-chome, Tsurumi-ku, Yokohama-shi, Kanagawa 230-0001 Japan